Novel Sensor-Based Interfaces and Their Applications

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Message from the Guest Editors

The objective of this Special Issue is to invite original research articles and reviews on various research areas, such as:

- Innovative sensor interfaces for augmented and virtual reality;
- Sensor interface technologies for the metaverse and immersive environments;
- Advances in sensor interfaces for the Internet of Things;
- Challenges and opportunities in brain–computer interfaces and electromyography sensors.

The scope of this Special Issue is not limited to these topics and welcomes contributions from related research areas.

We look forward to receiving your **contributions**.

Special Issue

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Message from the Editor-in-Chief

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